

LARGE CURRENT MULTILAYER CHIP BEADS / LCB TYPE

FEATURES

- ◆ Low DCR, small package
- ◆ High current handling capacity
- ◆ Nickel barrier terminations provide excellent solder heat resistance
- ◆ Suitable for flow and reflow soldering and high current applications

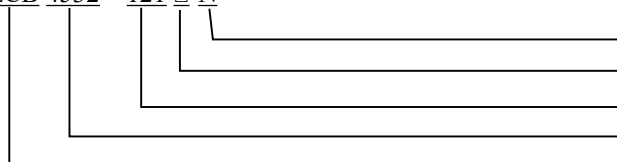


APPLICATIONS

- ◆ I/O interfaces.
- ◆ Computer motherboards.
- ◆ Various categories of consumer electronics.

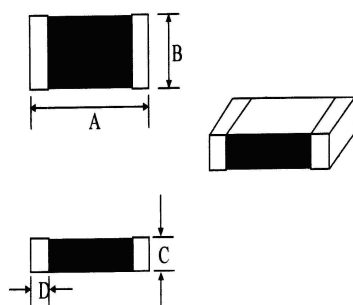
ORDERING CODE

LCB 4532 – 121 □-N



Note: lead-free
Tolerance (Y:±25%)
Inductance
Dimension (AxB)
Product Symbol

DIMENSIONS (UNIT: mm)



A	4.5 ± 0.2	m/m
B	3.2 ± 0.2	m/m
C	1.5 ± 0.2	m/m
D	0.5 ± 0.3	m/m



CORE MASTER ENTERPRISE CO., LTD.

<http://www.coremaster.com.tw>

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ELECTRICAL CHARACTERISTICS LCB4532

Part No.	Impedance(Ω) AT 100MHz	DC Resistance(Ω) Max	Rated Current(A) Max
LCB 4532-700 □-N	70	0.030	6.0
LCB 4532-121 □-N	120	0.050	3.0

